BB02-HK

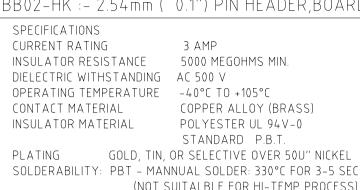
CUSTOMER PRODUCT SPECIFICATION SHFFT

5.08

RoHS Compliant

0.64mm SQ PIN

BB02-HK: - 2.54mm (0.1") PIN HEADER BOARD SPACER DUAL ROW 04 to 80 CONTACTS



(NOT SUITALBLE FOR HI-TEMP PROCESS) NYLON 6T - IR REFLOW: 260°C FOR 10 SEC WAVE: 230°C FOR 5-10 SEC

BB02-KW

BB02-ID

MANNUAL SOLDER: 350°C FOR 3-5 SEC

PACKED LOOSE IN BAG OR BOX.

MATES WITH :- BB02-JM BB02-KM BB02-LF BB02-KA BB02-KQ BB02-KD BB02-KS BB02-KF BB02-KT BB02-KG BB02-KU

BB02-KH

BB02-KK

RECOMMENDED PC BOARD HOLF LAYOUT

CONTACT PLATING OPTIONS

K = GOLD FLASH (STANDARD) A = 1000 GOLD ON CONTACT/GOLD FLASH ON TAIL

B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL

C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL

T = BRIGHT TIN

M = MATT TIN

D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL

E = 10U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

F = 15U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

G = 30U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

PIN LENGTH A (1/10mm) PLEASE SPECIFY PIN I FNGTH REQUIRED I.E. 2.5 mm = 25

STANDARD = 60 TOL.: ±0.2MM

HOW TO ORDER

В \triangle

> PIN LENGTH B (1/10mm) PLEASE SPECIFY PIN I FNGTH REQUIRED I.E. 2.5 mm = 25

STANDARD = 30

2.54

TOL.: ±0.2MM

INSULATOR MATERIAL 2 BLANK = PBT (STANDARD) 6T = NYLON 6T (HI-TEMP)

PIN LENGTH C (1/10mm) PLEASE SPECIEY PIN I FNGTH REQUIRED I.E. 2.5mm = 25

STANDARD = 53

TOL: +0.2MM

 $2.54 \times (No. of Contacts/2-1)$

2.54 x (No. of Contacts/2)

 $\phi 1.02 \pm 0.05$

2.54 ± 0.05

Typ. (Non-Accum.)

Тур.

Scale:	5:1	THIRD ANGLE	Unstated Tolerances: 0 Dec Places 1 Dec Places	Material
Drawn:	SJT		2 Dec Places 3 Dec Places	SEE NOTE
App'd:	XXX	Title PIN HEADER		NOT TO SCALE
Date:	18 JAN '08	Revision: 1.3		Unit mm



Гуре: Е	BB02-HK
В	B02-HK
rawing	Number:

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